

FDN86246 N-Channel PowerTrench[®] MOSFET 150 V, 1.6 A, 261 m Ω

Features

- Max r_{DS(on)} = 261 mΩ at V_{GS} = 10 V, I_D = 1.6 A
- Max $r_{DS(on)}$ = 359 m Ω at V_{GS} = 6 V, I_D = 1.4 A
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability in a widely used surface mount package
- Fast switching speed
- 100% UIL tested
- RoHS Compliant

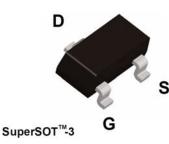


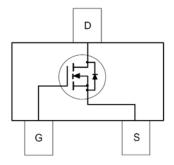
General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process that has been optimized for $r_{DS(on)}$, switching performance and ruggedness.

Application

PD Switch





MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{DS}	Drain to Source Voltage		150	V	
V _{GS}	Gate to Source Voltage		±20	V	
I _D	-Continuous	(Note 1a)	1.6	Α	
	-Pulsed		6		
E _{AS}	Single Pulse Avalanche Energy	(Note 3)	13	mJ	
P _D	Power Dissipation	(Note 1a)	1.5		
	Power Dissipation	(Note 1b)	0.6		
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	(Note 1)	75	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	80	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
246	FDN86246	SSOT-3	7 "	8 mm	3000 units

December 2010

Cteristics Drain to Source Breakdown Voltage Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate to Source Leakage Current	$I_D = 250 \mu A, V_{GS} = 0 V$ $I_D = 250 \mu A,$ referenced to 25 °C $V_{DS} = 120 V, V_{GS} = 0 V$	150			
Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate to Source Leakage Current	$I_D = 250 \ \mu$ A, referenced to 25 °C	150			
Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate to Source Leakage Current	$I_D = 250 \ \mu$ A, referenced to 25 °C				V
Gate to Source Leakage Current	1/2 - 120 1/2 / - 0 1/2		106		mV/°C
	$v_{DS} = 120 v, v_{GS} = 0 v$			1	μA
4	V _{GS} = ±20 V, V _{DS} = 0 V			±100	nA
Cteristics (Note 2)					
Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	2	3.4	4	V
Gate to Source Threshold Voltage	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		-9	-	mV/°C
			195	261	
Static Drain to Source On Resistance			242	359	mΩ
			359	481	-
Forward Transconductance	V _{DS} = 10 V, I _D = 1.6 A		4		S
Characteristics				r	1
			168	225	pF
				30	pF
	f = 1 MHz		1.6	5	pF
Gate Resistance			0.9		Ω
Characteristics		L	l		1
			4.5	10	ns
					ns
					ns
			-		ns
	$V_{cc} = 0 V to 10 V$		-	-	nC
iotal oato onalgo			1.6	3	nC
Total Gate Charge	$V_{CS} = 0 \times 10 5 \times 10^{-5} = 15 \times 10^{-5}$		-	-	-
Total Gate Charge Gate to Source Gate Charge	$V_{GS} = 0 V \text{ to } 5 V$ $V_{DD} = 75 V,$ $I_{D} = 1.6 A$		0.9		nC
Gate to Source Gate Charge	$V_{GS} = 0.0050$ $V_{DD} = 750$, $I_D = 1.6 A$		0.9 0.8		nC nC
Gate to Source Gate Charge Gate to Drain "Miller" Charge	$V_{GS} = 0.0 \text{ to } 5.0 \text{ V}_{DD} = 75 \text{ V},$ $I_D = 1.6 \text{ A}$				-
Gate to Source Gate Charge Gate to Drain "Miller" Charge rce Diode Characteristics	I _D = 1.6 A		0.8	1.3	-
Gate to Source Gate Charge Gate to Drain "Miller" Charge	$V_{GS} = 0 V to 5 V V_{DD} = 75 V,$ $I_{D} = 1.6 A$ $V_{GS} = 0 V, I_{S} = 1.6 A (Note 2)$ $I_{F} = 1.6 A, di/dt = 100 A/\mu s$			1.3 70	nC
	Temperature Coefficient Static Drain to Source On Resistance Forward Transconductance Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance	Temperature CoefficientID $= 250 \ \mu$ A, referenced to $25 \ ^{\circ}$ CStatic Drain to Source On Resistance $V_{GS} = 10 \ V, ID = 1.6 \ A$ $V_{GS} = 6 \ V, ID = 1.4 \ A$ VGS $= 10 \ V, ID = 1.6 \ A, TJ = 125 \ ^{\circ}$ CForward Transconductance $V_{DS} = 10 \ V, ID = 1.6 \ A, TJ = 125 \ ^{\circ}$ CForward Transconductance $V_{DS} = 10 \ V, ID = 1.6 \ A$ CharacteristicsInput Capacitance $V_{DS} = 75 \ V, V_{GS} = 0 \ V, f = 1 \ MHz$ Reverse Transfer CapacitanceGate ResistanceCharacteristicsTurn-On Delay TimeRise TimeVDD = 75 \ V, ID = 1.6 \ A, TURN-Off Delay TimeFall Time	Temperature CoefficientID 250μ A, referenced to $25 °C$ Static Drain to Source On Resistance $V_{GS} = 10 V, I_D = 1.6 A$ Static Drain to Source On Resistance $V_{GS} = 6 V, I_D = 1.4 A$ $V_{GS} = 10 V, I_D = 1.6 A, T_J = 125 °C$ Forward Transconductance $V_{DS} = 10 V, I_D = 1.6 A$ Input Capacitance $V_{DS} = 10 V, I_D = 1.6 A$ Output Capacitance $V_{DS} = 75 V, V_{GS} = 0 V, f = 1 MHz$ Reverse Transfer Capacitance $f = 1 MHz$ Gate Resistance $Q_{DD} = 75 V, I_D = 1.6 A, f = 1.6 A,$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

a) 80 °C/W when mou 1 in² pad of 2 oz co



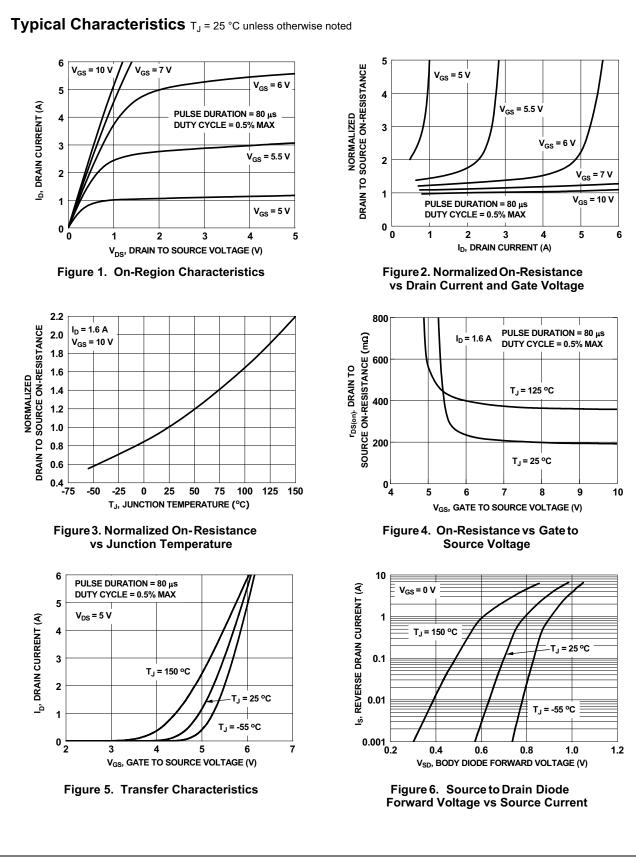
FDN86246 N-Channel PowerTrench[®] MOSFET

©2010 Fairchild Semiconductor Corporation FDN86246 Rev.C

88888

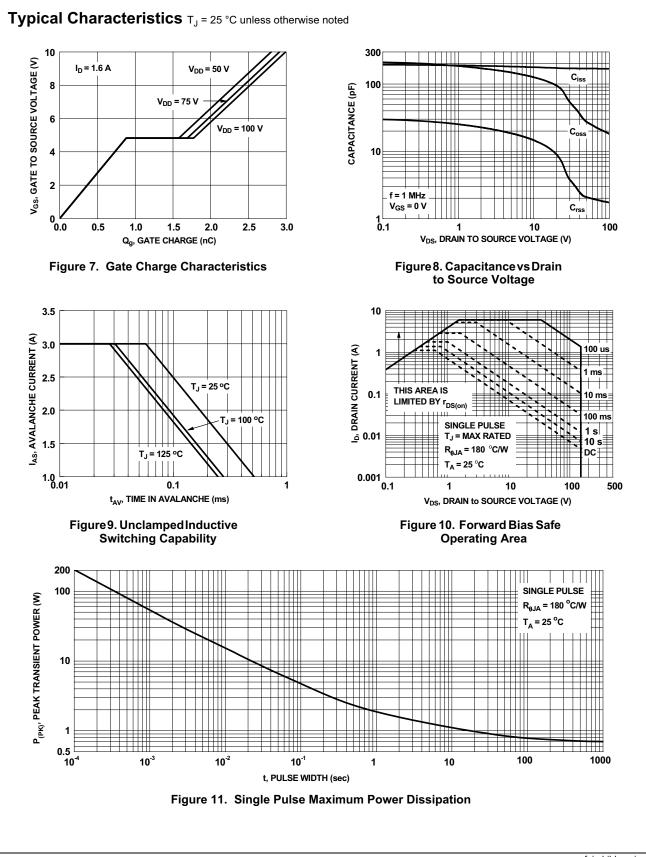
3. Starting T_J = 25 °C; N-ch: L = 3 mH, I_{AS} = 3 A, V_DD = 150 V, V_{GS} = 10 V.

2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.



©2010 Fairchild Semiconductor Corporation FDN86246 Rev.C

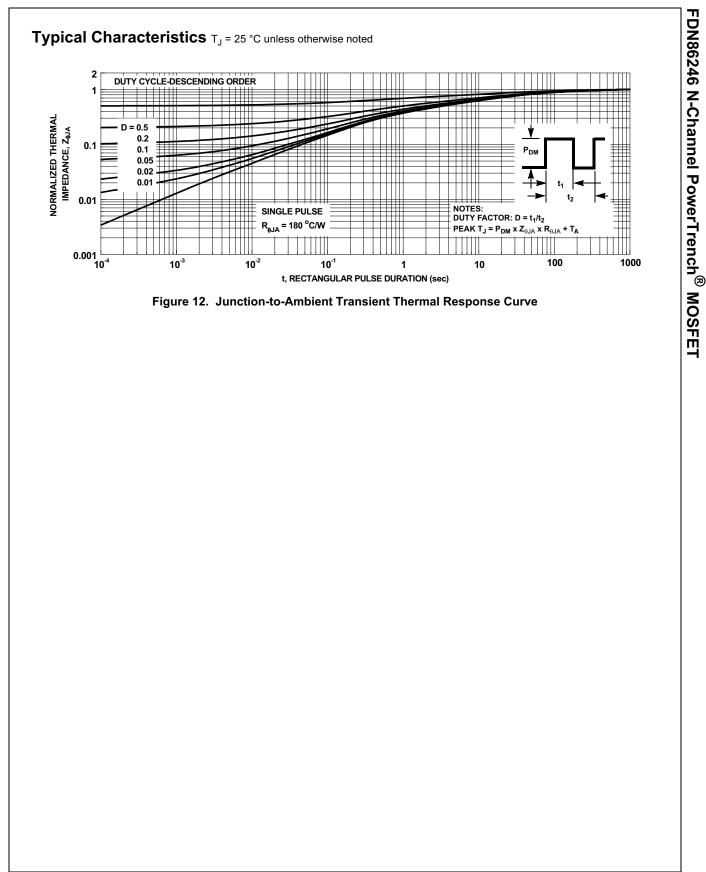
www.fairchildsemi.com

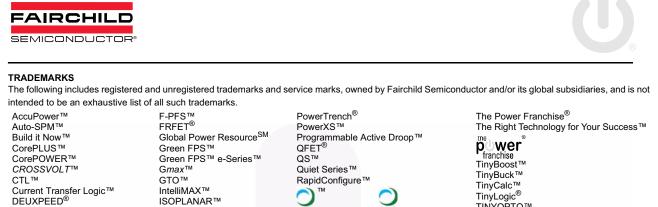


©2010 Fairchild Semiconductor Corporation FDN86246 Rev.C

www.fairchildsemi.com

FDN86246 N-Channel PowerTrench[®] MOSFET





тм

SignalWise™

SmartMax™

STEALTH™

SuperFET[®]

SuperSOT™-3

SuperSOT™-6

SuperSOT™-8

SupreMOS®

SyncFET™

Sync-Lock™

SPM®

SMART START™

Saving our world, 1mW/W/kW at a time™

FDN86246 N-Channel PowerTrench[®] MOSFE

GENERAL ®* *Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

IntelliMAX[™]

MegaBuck™

MicroFET™

MicroPak™

MicroPak2™

MillerDrive™

MotionMax™

OptiHiT™

Motion-SPM™

OPTOLOGIC®

PDP SPM™

Power-SPM™

OPTOPLANAR[®]

ISOPLANAR™

MICROCOUPLER™

DISCLAIMER

Dual Cool™

EcoSPARK[®]

ESBC™

Fairchild®

Fairchild Semiconductor®

FACT Quiet Series™

F

FACT[®]

FAST®

FPS™

FastvCore™

FETBench™

FlashWriter[®] *

EfficentMax™

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used here in:

- Life support devices or systems are devices or systems which, (a) are 1. intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

TinyLogic®

TINYOPTO™

TinyPower™

TriFault Detect™

TRUECURRENT™*

TinyPWM™

TinyWire™

uSerDes™

UniFET™

VisualMax™

Ultra FRFET™

UHC®

VCX™

XS™

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.
	-	Rev

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Fairchild Semiconductor: